

EVAFLEX® 5-SE

自锁式, 水平插拔, 0.5 mm, FFC/FPC连接器

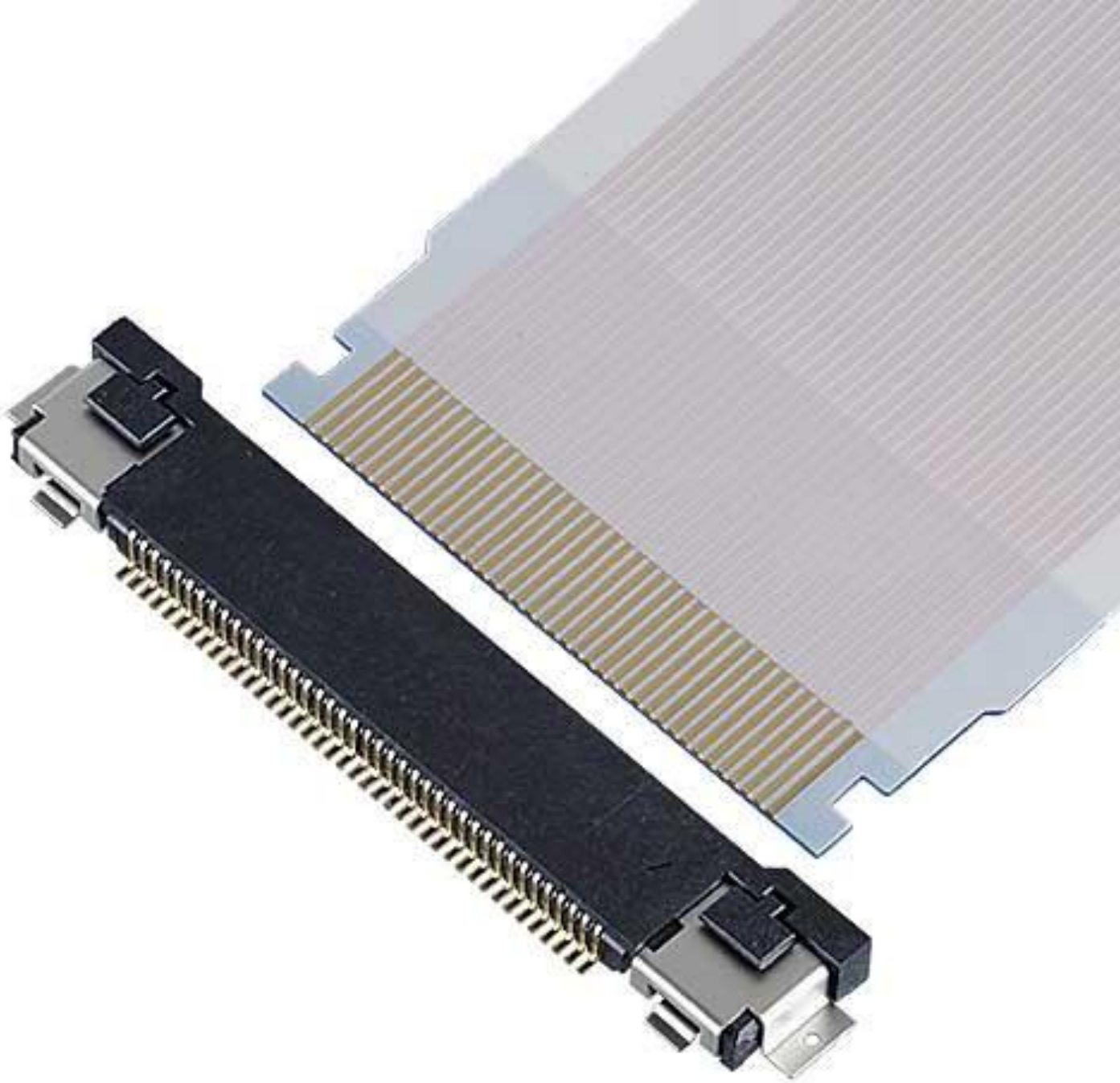
Product Specifications:

Board Pitch	0.5 mm
Wiping Length	1.45 mm
Size	Height 2.40 +/- 0.20 mm
	Width 13.10 + (0.5 x pin count) mm
	Depth 5.90 +/- 0.20 mm
Pin counts	Range 10 to 60
	Available 10, 15, 22, 30, 40, 45, 50, 60

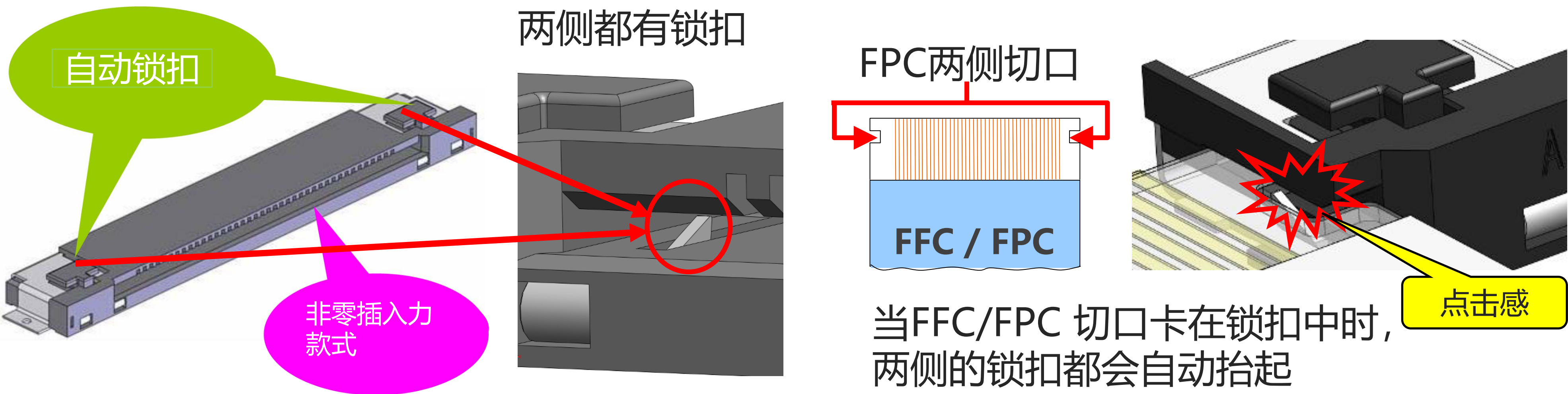
Applicable FPC/FFC:

FPC/FFC Type	Non-shielded FFC/FPC
FPC/FFC Contact Point	Top
FPC/FFC Thickness	FFC : 0.30 +/- 0.05 mm
	FPC : 0.30 +/- 0.03 mm

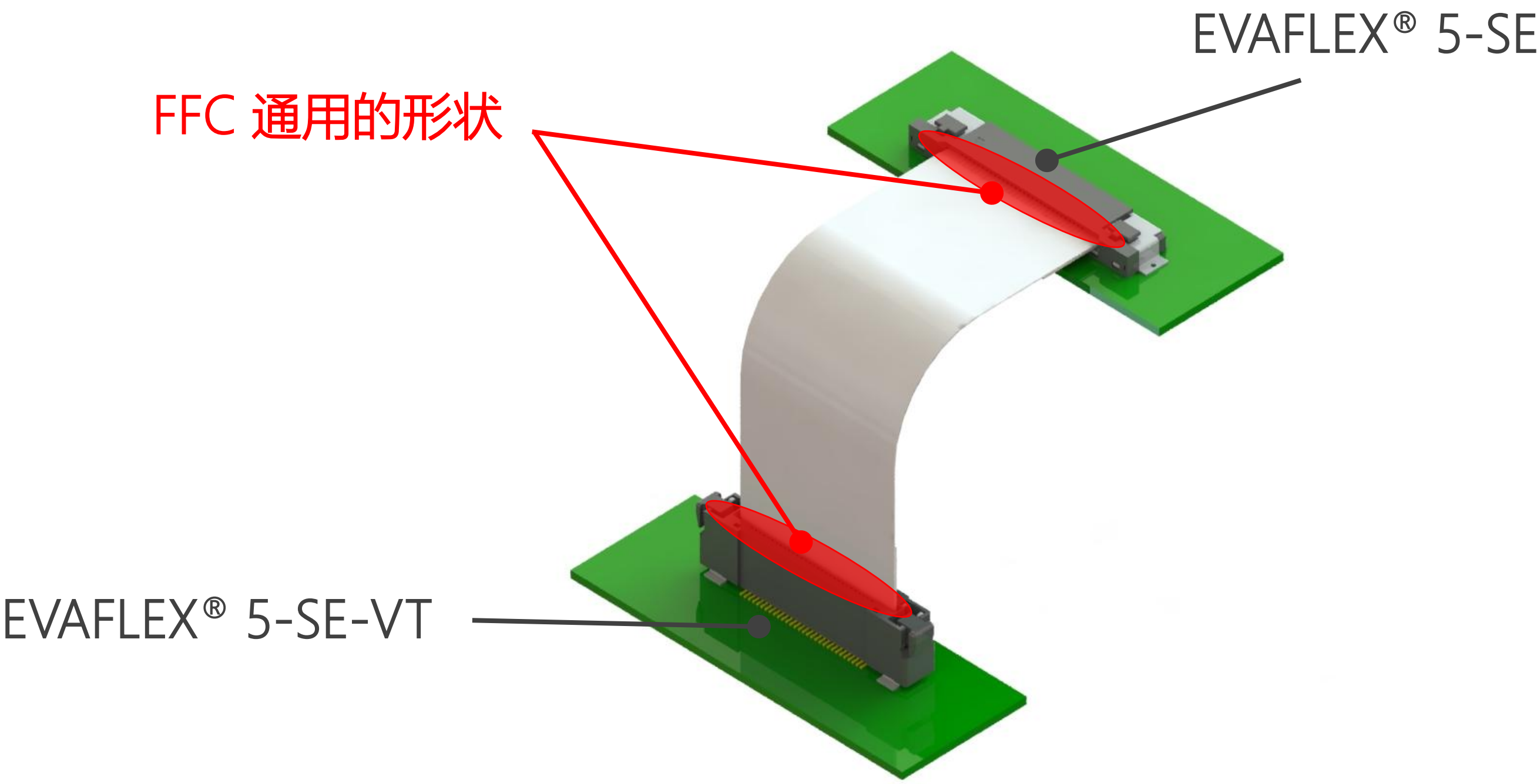
*如您需要了解未列出或不在范围内的Pin数，请咨询我们。



自动锁扣的设计便于操作,适用于手动或机器人装配



I-PEX特有的W-Point 结构，提供高接触可靠性



EVAFLEX® 系列: 更多选择的自动锁扣连接器

速度更快，耐高温(125 °C) : EVAFLEX® 5-SE-G HT

	EVAFLEX® 5-SE-G HT
高度 (mm)	6.60 +/- 01
工作温度	up to 125°C
参考性能	V-by-one HS 1.4 (4+ Gbps)

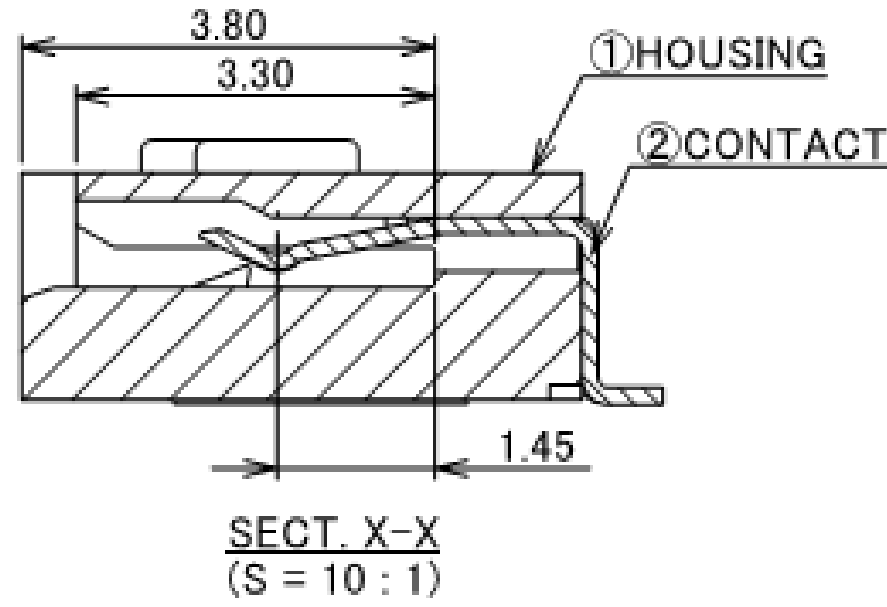
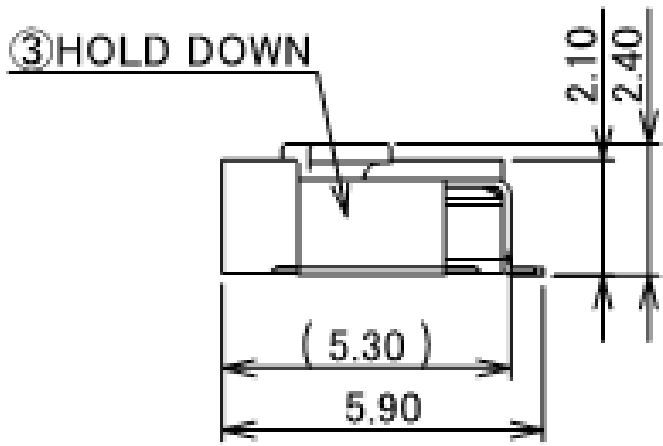
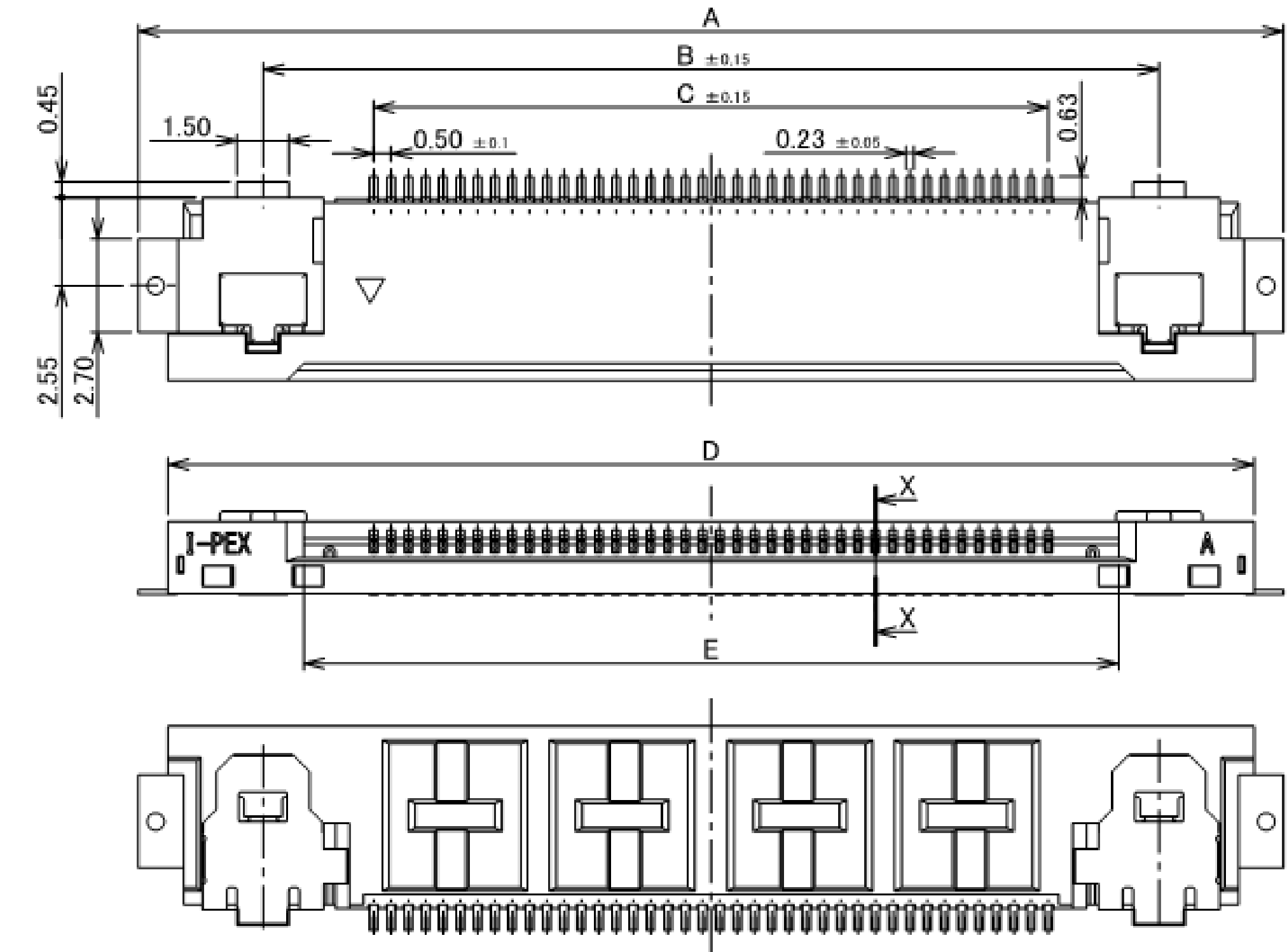


Component Parts Details

Connector Assembly

Recommended P/N		20526-0**E-01				
PART NO.	Pos.	A	B	C	D	E
20526-010E-01	10	18.10	10.90	4.50	16.40	8.56
20526-015E-01	15	20.60	13.40	7.00	18.90	11.06
20526-022E-01	22	24.10	16.90	10.50	22.40	14.56
20526-030E-01	30	28.10	20.90	14.50	26.40	18.56
20526-040E-01	40	33.10	25.90	19.50	31.40	23.56
20526-045E-01	45	35.60	28.40	22.00	33.90	26.06
20526-050E-01	50	38.10	30.90	24.50	36.40	28.56
◆20526-055E-01	55	40.60	33.40	27.00	38.90	31.06
20526-060E-01	60	43.10	35.90	29.50	41.40	33.56

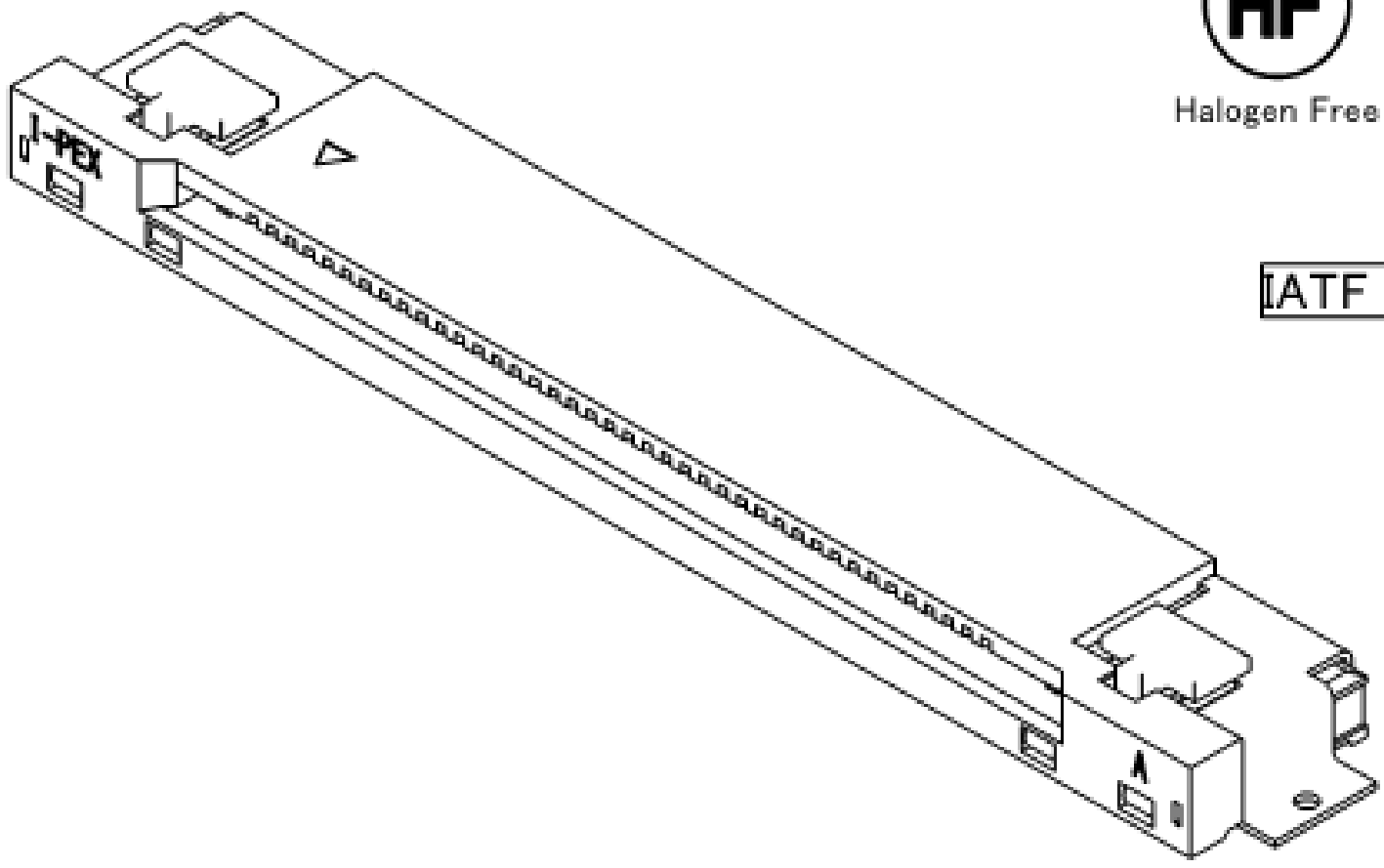
◆ MARK MEANS NOT AVAILABLE



3	HOLD DOWN	PHOSPHOR BRONZE	SOLDERING AREA : Sn 2.00 μ m MIN. OVER Ni 1.00 μ m MIN.
2	CONTACT	PHOSPHOR BRONZE	CONTACT AREA : Au 0.10 μ m MIN. OVER Ni 1.00 μ m MIN. SOLDERING AREA : Au 0.03 μ m MIN. OVER Ni 1.00 μ m MIN.
1	HOUSING	LCP	UL94V-0 BLACK
NO.	DISCRIPTION	MATERIAL	FINISH , REMARKS



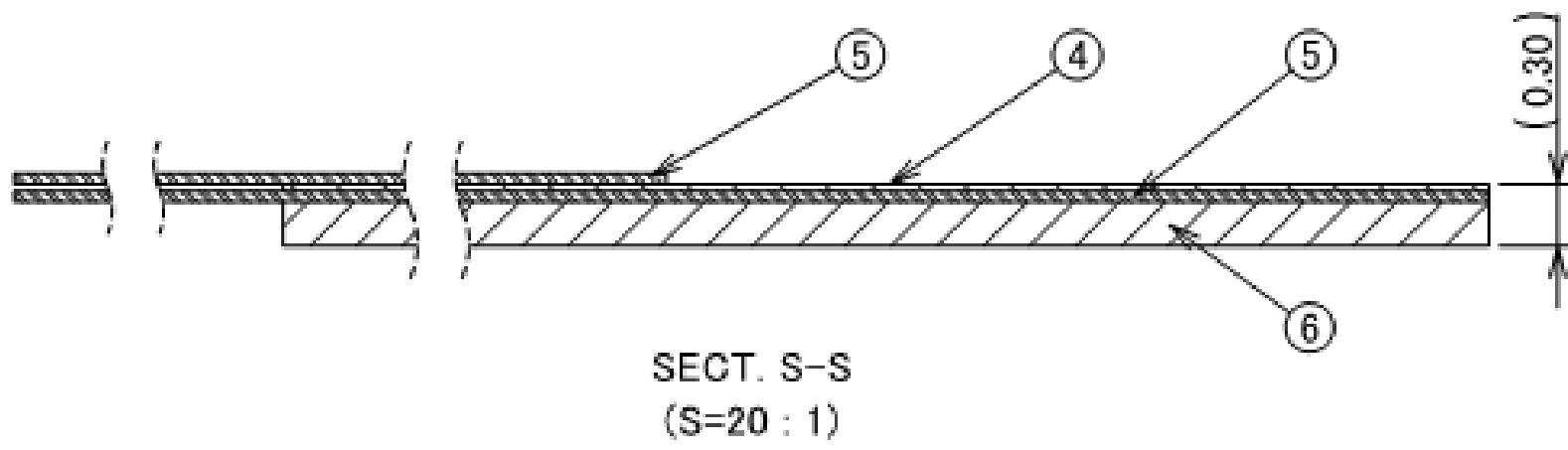
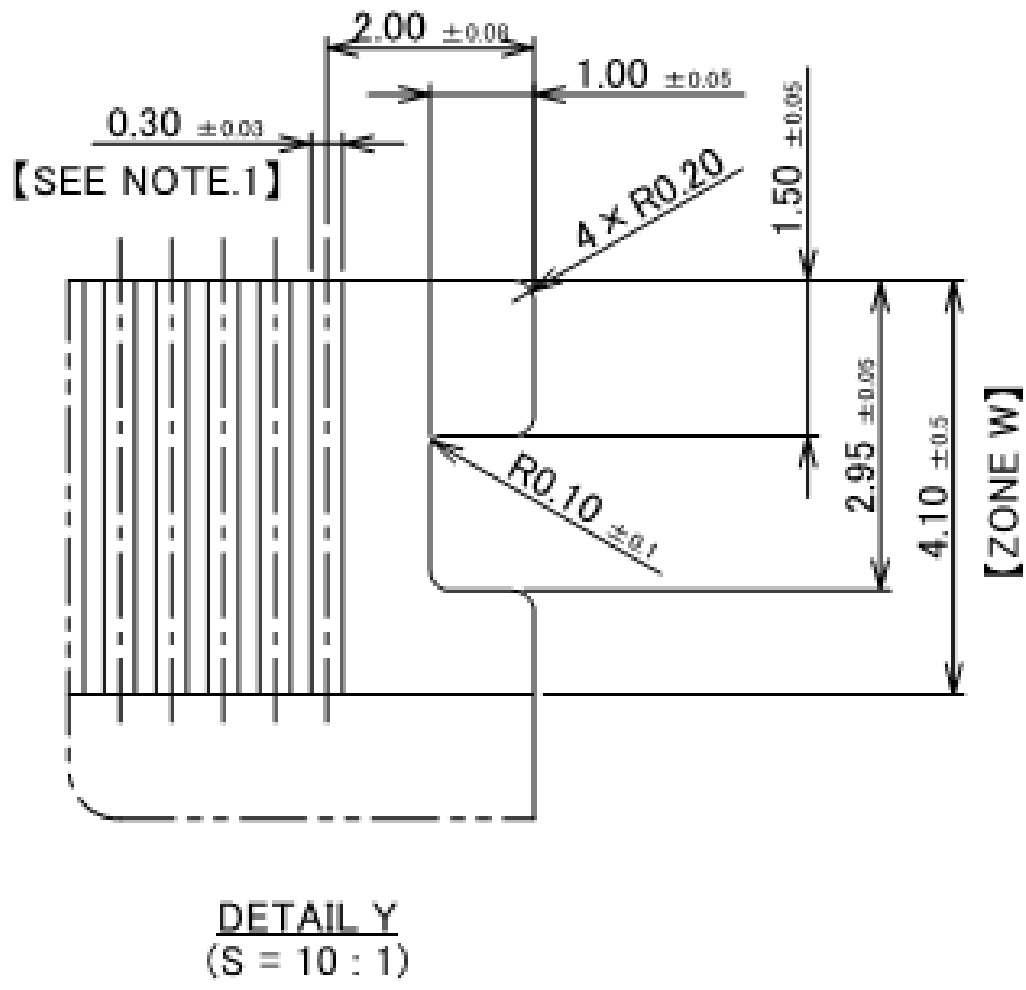
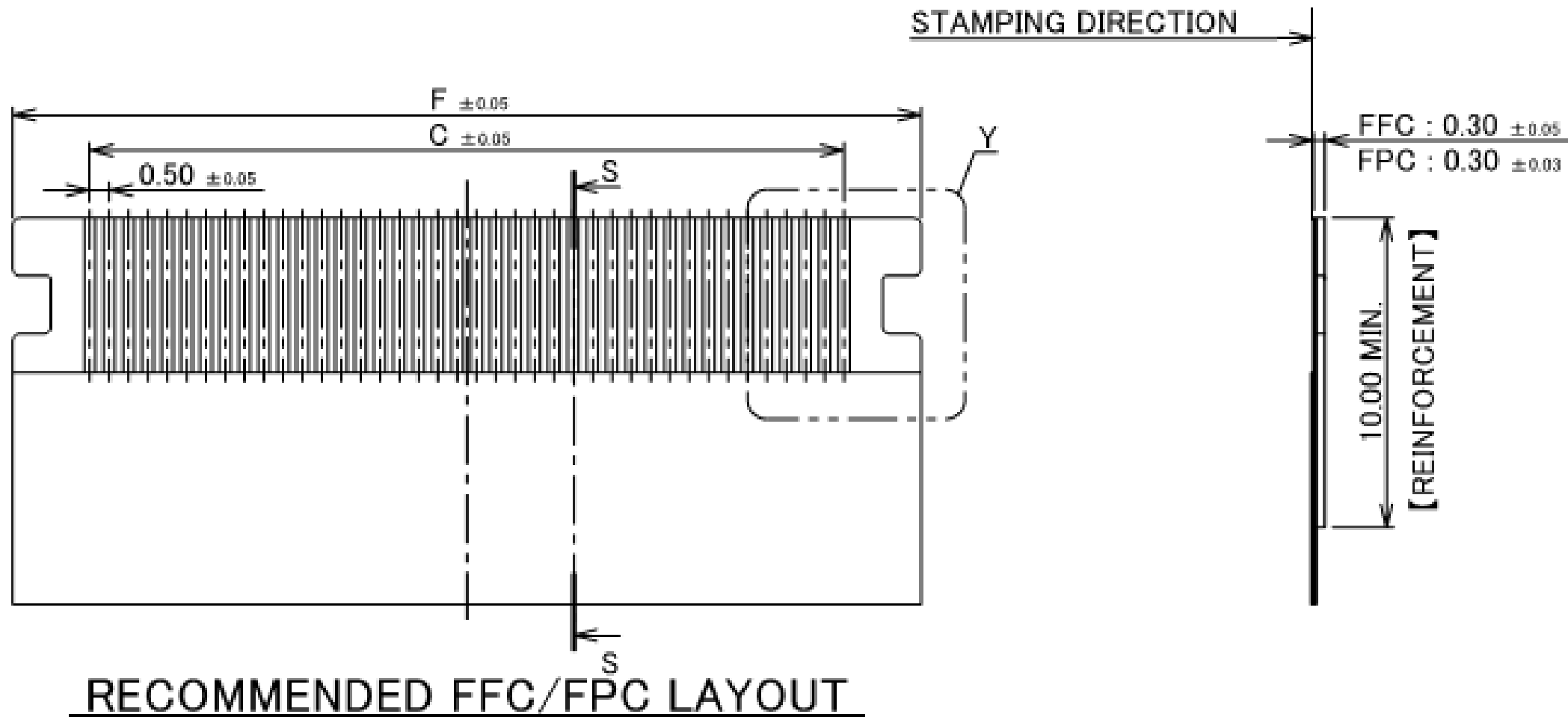
ATF 16949 Certified



Connector Assembly

Recommended P/N		20526-0**E-01		
PART NO.	Pos.	C	F	
20526-010E-01	10	4.50	8.50	
20526-015E-01	15	7.00	11.00	
20526-022E-01	22	10.50	14.50	
20526-030E-01	30	14.50	18.50	
20526-040E-01	40	19.50	23.50	
20526-045E-01	45	22.00	26.00	
20526-050E-01	50	24.50	28.50	
◆20526-055E-01	55	27.00	31.00	
20526-060E-01	60	29.50	33.50	

◆MARK MEANS NOT AVAILABLE



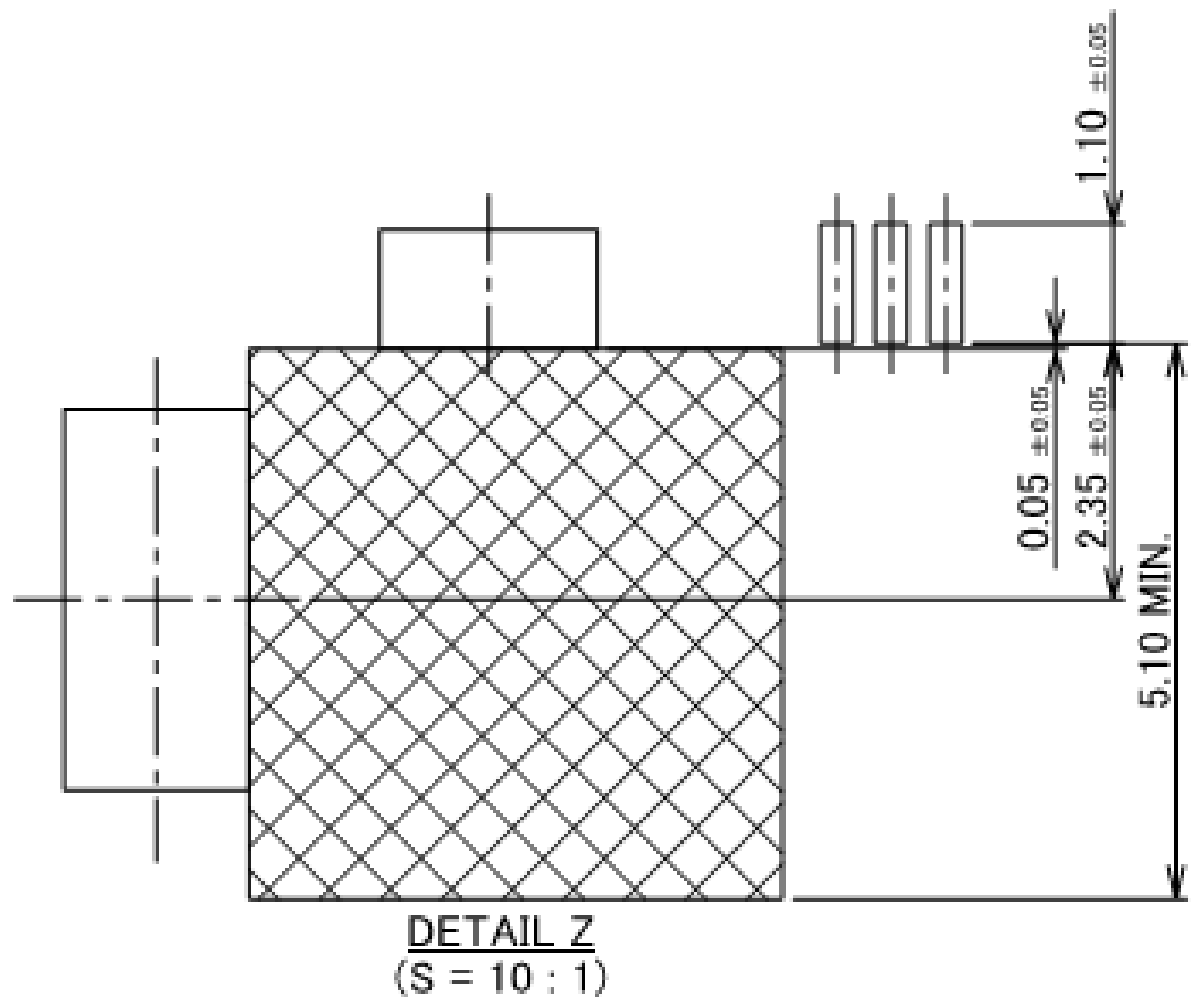
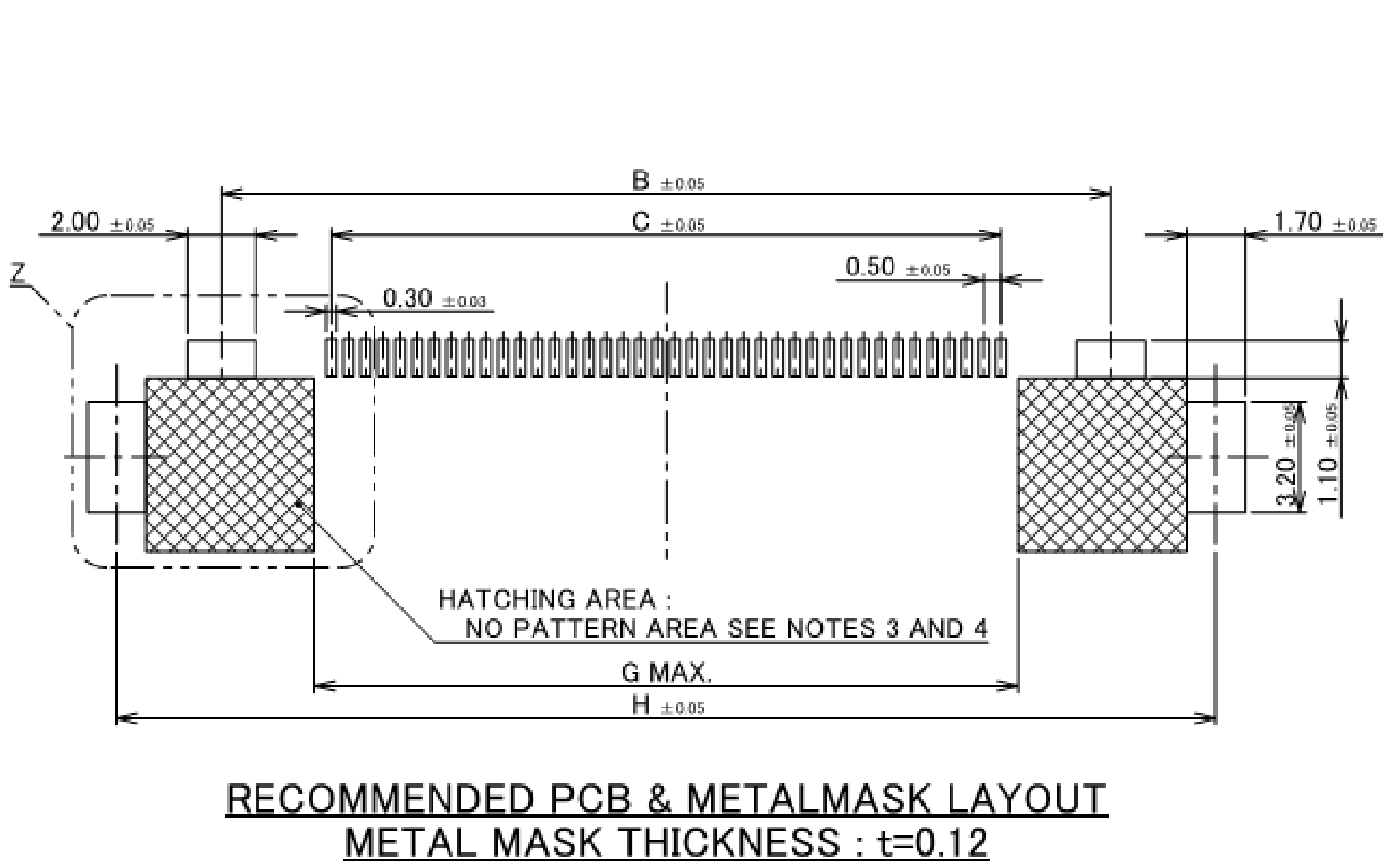
6	REINFORCED TAPE	ARBITRARY	
5	INSULATION FILM	ARBITRARY	
4	CONDUCTOR	COPPER ALLOY	CONTACT AREA: Au 0.05 μ m MIN. OVER Ni 0.5 μ m MIN.
NO.	DISCRIPTION	MATERIAL	FINISH

- NOTES.
1. CONTROL DIMENSION OF 【ZONE W】 WITH IN 0.30 $\pm$ 0.03
 2. SELECT A MATERIAL WITH A SOFTENING TEMPERATURE OF 85°C OR HIGHER FOR THE PATTERN ADHESIVE PART OF FFC.

Rev.15

Recommended P/N		20526-0**E-01			
PART NO.	Pos.	B	C	G	H
20526-010E-01	10	10.90	4.50	5.50	17.00
20526-015E-01	15	13.40	7.00	8.00	19.50
20526-022E-01	22	16.90	10.50	11.50	23.00
20526-030E-01	30	20.90	14.50	15.50	27.00
20526-040E-01	40	25.90	19.50	20.50	32.00
20526-045E-01	45	28.40	22.00	23.00	34.50
20526-050E-01	50	30.90	24.50	25.50	37.00
◆20526-055E-01	55	33.40	27.00	28.00	39.50
20526-060E-01	60	35.90	29.50	30.50	42.00

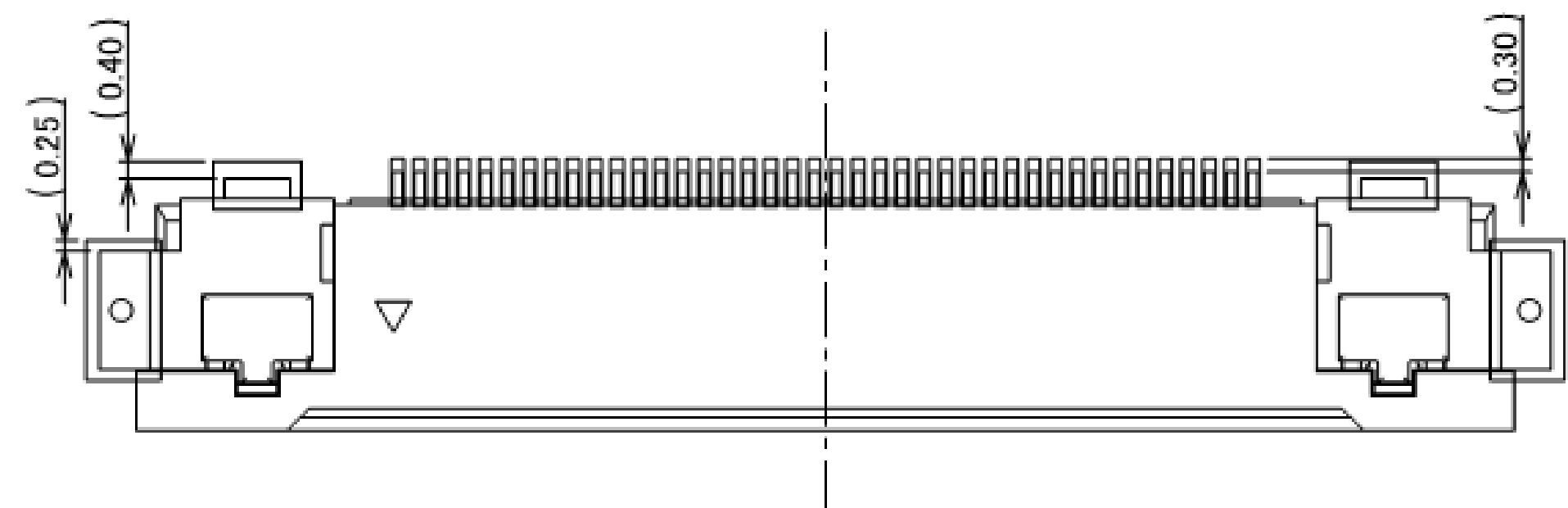
◆MARK MEANS NOT AVAILABLE



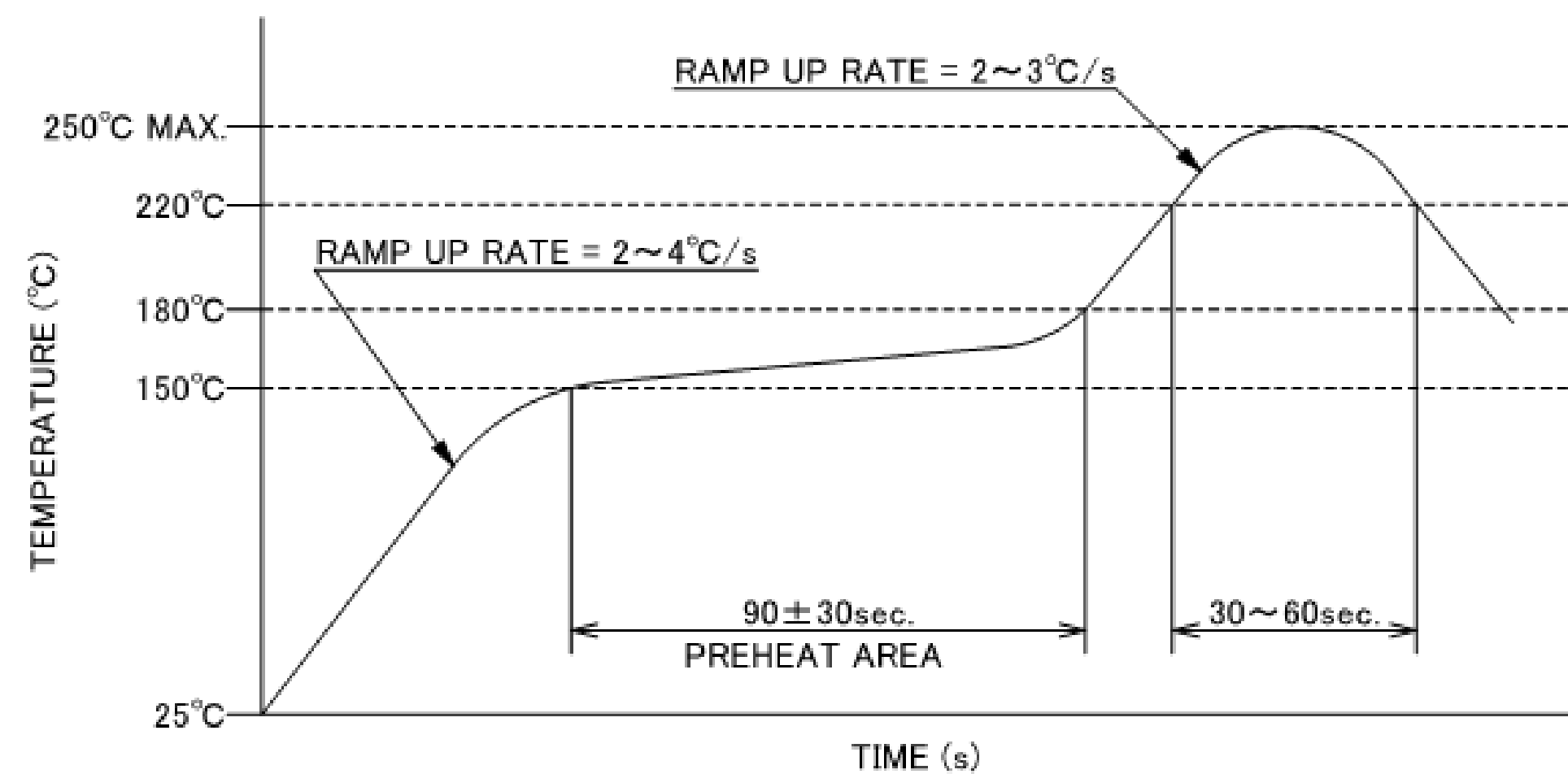
- NOTES.
3. DO NOT MOUNT ANOTHER COMPONENTS IN THIS AREA.
 4. SOLDER RESIST MUST BE APPLIED TO THIS AREA.

Rev.15

Connector Assembly



CONNECTOR ON RECOMMENDED FOOTPRINT PATTERN



SENJU METAL INDUSTRY CO., LTD. : M705-SHF(Sn96.5 Ag3.0 Cu0.5)

Rev.15

ITEMS	SPECIFICATION
RATING VOLTAGE	50V AC/DC (PER CONTACT PIN)
RATING AMPERAGE (FOR CONTACT)	0.50A AC/DC (PER CONTACT PIN) ※(AVAILABLE UP TO 15PIN) / 0.35A AC/DC(PER CONTACT PIN) ※(AVAILABLE FOR ALL PIN)
OPERATING TEMPERATURE	Using FFC : 233~358K(-40°C~+85°C) Using FPC : 233~398K(-40°C~+125°C)
OPERATING HUMIDITY	85% MAX.(NON-CONDENSING)
CONTACT RESISTANCE	INITIAL : 70mohm MAX. / AFTER TEST : ≦40mohm MAX.
INSULATION RESISTANCE	INITIAL : 500Mohm MIN. / AFTER TEST : 500Mohm MIN.
DIELECTRIC WITHSTANDING VOLTAGE	AC 250V 1min
DURABILITY	30 CYCLES
MATING FORCE (INITIAL / AFTER TEST)	10P : 6.0N MAX. 15P : 9.0N MAX. 22P : 13.2N MAX. 30P : 18.0N MAX. 40P : 24.0N MAX. 45P : 27.0N MAX. 50P : 30.0N MAX. 55P : 33.0N MAX. 60P : 36.0N MAX.
UNMATING FORCE (INITIAL / AFTER TEST)	10P : 0.90N MIN. 15P : 1.35N MIN. 22P : 1.98N MIN. 30P : 2.70N MIN. 40P : 3.60N MIN. 45P : 4.05N MIN. 50P : 4.50N MIN. 55P : 4.95N MIN. 60P : 5.40N MIN.
COPLANARITY	0.10mm MAX.
PRODUCT SPECIFICATION	PRS-1562
TEST REPORT	TR-10048
PACKING STANDARD	300-861
INSTRUCTION MANUAL	HIM-10008
APPEARANCE CRITERIA No.	QLS-A***

Rev.15

Custom Connectors Available

RF Connectors

MHF® series



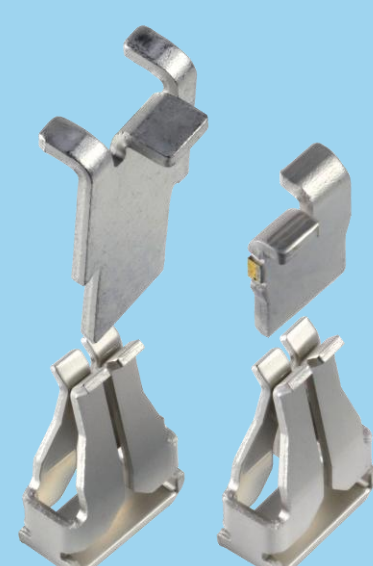
CABLINE® series

Micro-Coaxial/Twinaxial Connectors

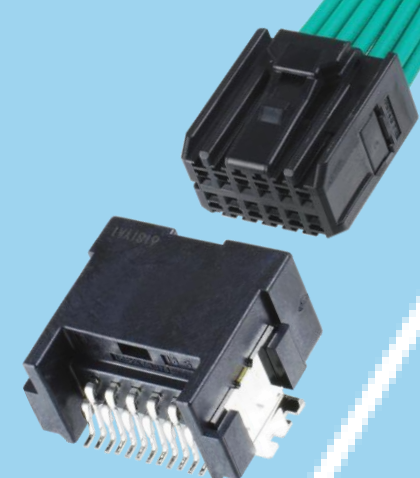


Wire-to-Board Connectors/ Terminals

AP series



ISH® series



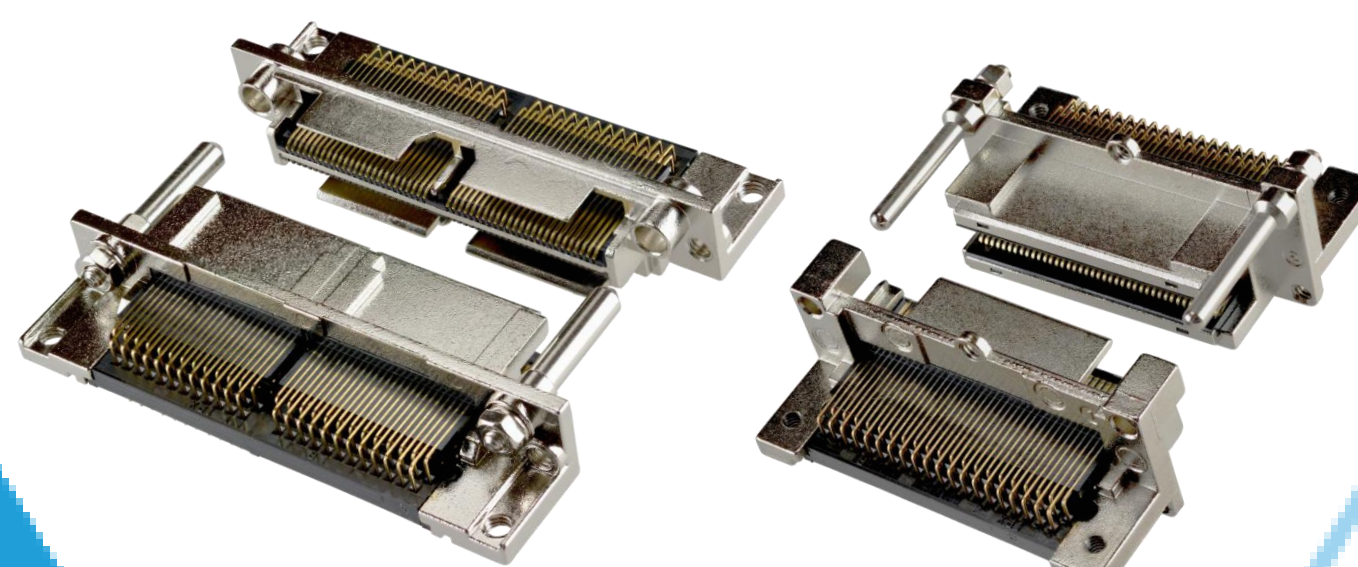
NOVASTACK® series



Board-to-Board Connectors

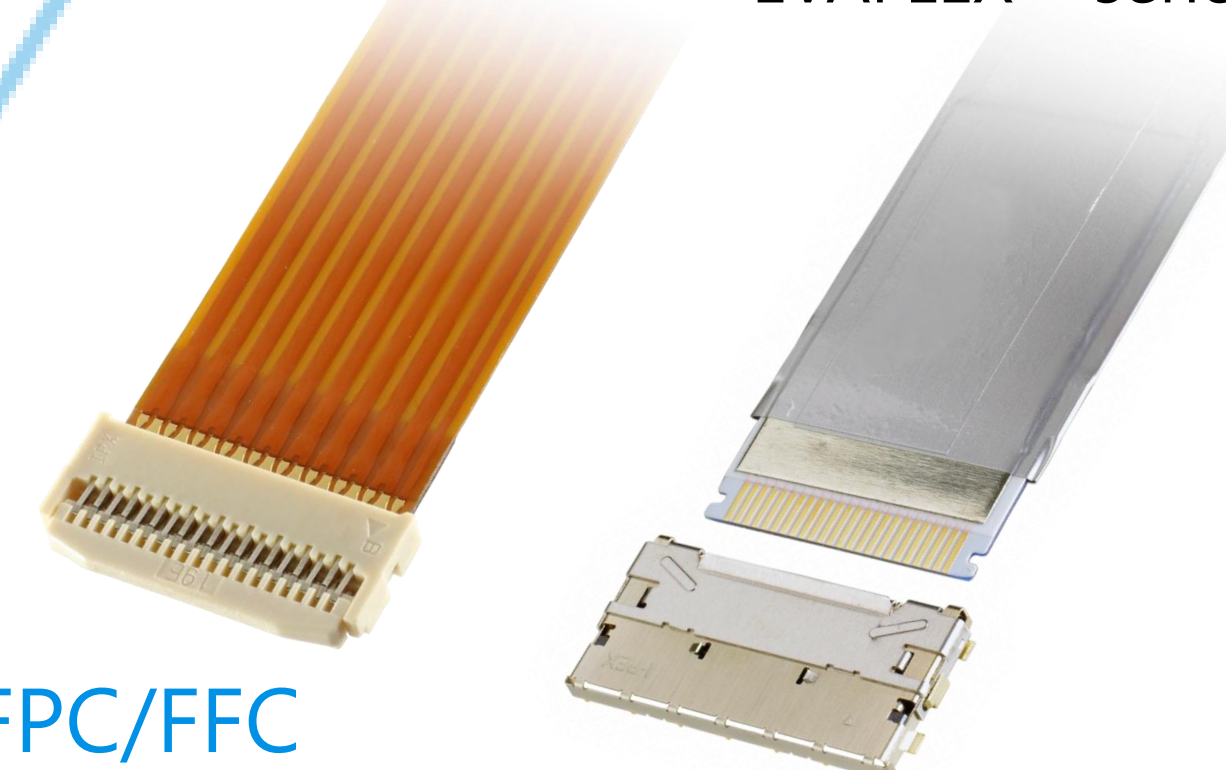


I/O Connectors



MINIDOCK™ series

MINIFLEX® series EVAFLEX® series



FPC/FFC Connectors



Inquiry



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